

ST13003

HIGH VOLTAGE FAST-SWITCHING NPN POWER TRANSISTOR

- MEDIUM VOLTAGE CAPABILITY
- LOW SPREAD OF DYNAMIC PARAMETERS
- MINIMUM LOT-TO-LOT SPREAD FOR RELIABLE OPERATION
- VERY HIGH SWITCHING SPEED

APPLICATIONS:

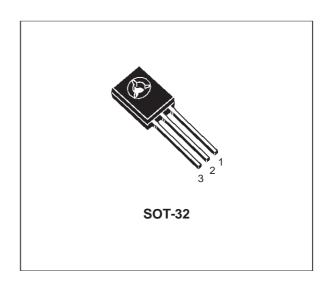
- ELECTRONIC BALLASTS FOR FLUORESCENT LIGHTING
- SWITCH MODE POWER SUPPLIES

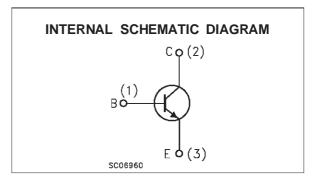
DESCRIPTION

The device is manufactured using high voltage Multi Epitaxial Planar technology for high switching speeds and medium voltage capability.

It uses a Cellular Emitter structure with planar edge termination to enhance switching speeds while maintaining the wide RBSOA.

The device is designed for use in lighting applications and low cost switch-mode power supplies.





ABSOLUTE MAXIMUM RATINGS

Symbol	Parameter	Value	Unit	
V _{CES}	Collector-Emitter Voltage (V _{BE} = 0)	700	V	
V _{CEO}	Collector-Emitter Voltage (I _B = 0)	400	V	
V _{EBO}	Emitter-Base Voltage $(I_C = 0, I_B = 0.75 \text{ A}, t_p < 10\mu\text{s}, T_j < 150^{\circ}\text{C})$	BV _{EBO}	V	
Ic	Collector Current	1.5	Α	
I _{CM}	Collector Peak Current (t _p < 5 ms)	3	Α	
lΒ	Base Current	0.75	Α	
I _{BM}	Base Peak Current (tp < 5 ms)	1.5	Α	
P _{tot}	Total Dissipation at T _c = 25 °C	40	W	
T _{stg}	Storage Temperature	-65 to 150	°C	

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THERMAL DATA

R _{thj-case}	Thermal Resistance Junction-case	Max	3.12	°C/W
R _{thj-amb}	Thermal Resistance Junction-ambient	Max	89	°C/W

ELECTRICAL CHARACTERISTICS ($T_{case} = 25$ °C unless otherwise specified)

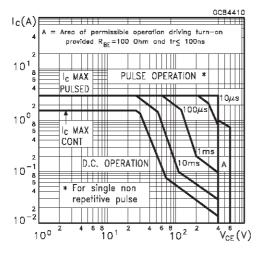
Symbol	Parameter	Test Conditions		Min.	Тур.	Max.	Unit
I _{CEV}	Collector Cut-off Current (V _{BE} = -1.5V)	V _{CE} = 700V V _{CE} = 700V	$T_j = 125$ °C			1 5	mA mA
BV _{EBO}	Emitter-Base Breakdown Voltage (I _C = 0)	I _E = 10 mA		9		18	V
V _{CEO(sus)*}	Collector-Emitter Sustaining Voltage (I _B = 0)	I _C = 10 mA L = 25mH		400			V
V _{CE(sat)} *	Collector-Emitter Saturation Voltage	I _C = 0.5 A I _C = 1 A I _C = 1.5 A	$I_B = 0.1 A$ $I_B = 0.25 A$ $I_B = 0.5 A$			0.5 1 3	V V V
V _{BE(sat)} *	Base-Emitter Saturation Voltage	I _C = 0.5 A I _C = 1 A	$I_B = 0.1 A$ $I_B = 0.25 A$			1.0 1.2	V
h _{FE}	DC Current Gain	I _C = 0.5 A Group A Group B I _C = 1 A	$V_{CE} = 2 V$ $V_{CE} = 2 V$	8 15 5		20 35 25	
t _r t _s	RESISTIVE LOAD Rise Time Storage Time Fall Time	I _C = 1 A I _{B1} = 0.2 A T _p = 25 μs	$V_{CC} = 125 \text{ V}$ $I_{B2} = -0.2 \text{ A}$			1.0 4.0 0.7	μs μs μs
ts	INDUCTIVE LOAD Storage Time	I _C = 1 A V _{BE} = -5 V V _{clamp} = 300 V	I _{B1} = 0.2 A L = 50 mH		0.8		μs

* Pulsed: Pulse duration = 300µs, duty cycle = 1.5 %

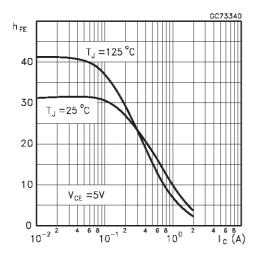
Note: Product is pre-selected in DC current gain (GROUP A and GROUP B). STMicroelectronics reserves the right to ship either groups according to production availability. Please contact your nearest STMicroelectronics sales office for delivery details.

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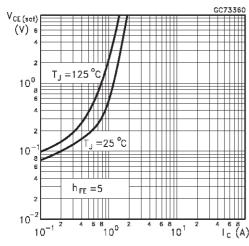
Safe Operating Areas



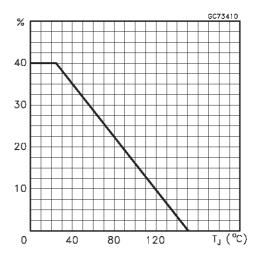
DC Current Gain



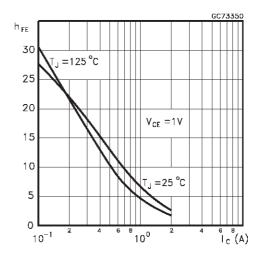
Collector Emitter Saturation Voltage



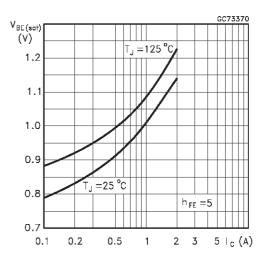
Derating Curve



DC Current Gain

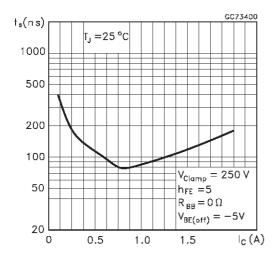


Base Emitter Saturation Voltage

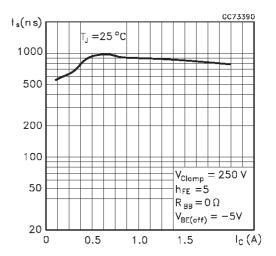


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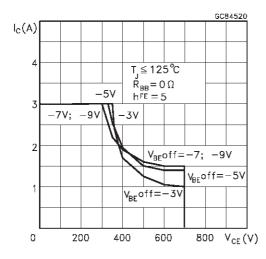
Inductive Fall Time



Inductive Storage Time



Reverse Biased SOA



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Figure 1: Inductive Load Switching Test Circuits.

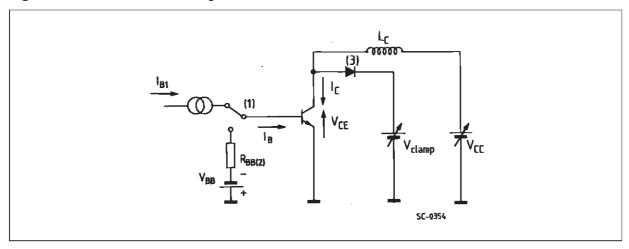
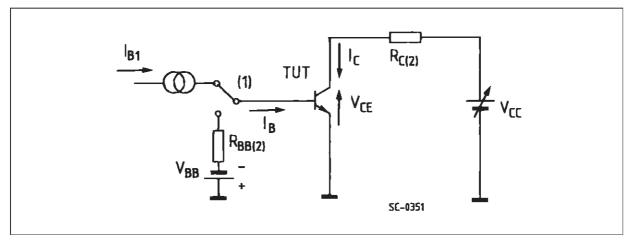
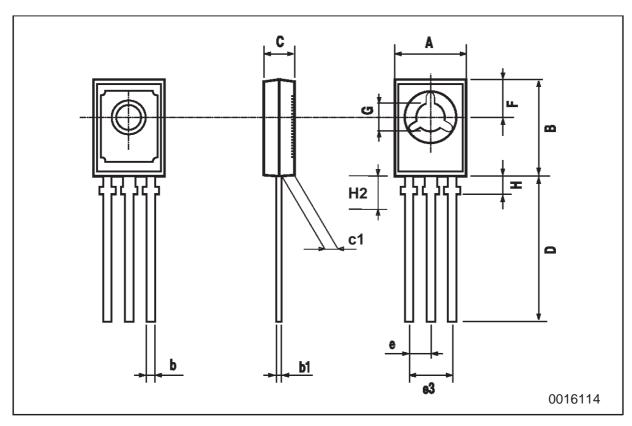


Figure 2: Resistive Load Switching Test Circuits.



SOT-32 (TO-126) MECHANICAL DATA

DIM.	mm			inch			
DIW.	MIN.	TYP.	MAX.	MIN.	TYP.	MAX.	
А	7.4		7.8	0.291		0.307	
В	10.5		10.8	0.413		0.445	
b	0.7		0.9	0.028		0.035	
b1	0.49		0.75	0.019		0.030	
С	2.4		2.7	0.040		0.106	
c1	1.0		1.3	0.039		0.050	
D	15.4		16.0	0.606		0.629	
е		2.2			0.087		
e3	4.15		4.65	0.163		0.183	
F		3.8			0.150		
G	3		3.2	0.118		0.126	
Н			2.54			0.100	



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